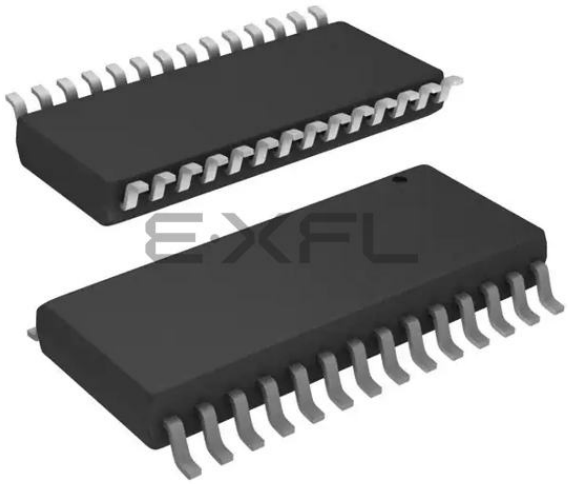

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## What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

## Applications of "Embedded - Microcontrollers"

| Details | |
|---|---|
| Product Status | Active |
| Core Processor | PIC |
| Core Size | 8-Bit |
| Speed | 40MHz |
| Connectivity | I²C, SPI, UART/USART |
| Peripherals | Brown-out Detect/Reset, HLVD, POR, PWM, WDT |
| Number of I/O | 25 |
| Program Memory Size | 8KB (4K x 16) |
| Program Memory Type | FLASH |
| EEPROM Size | 256 x 8 |
| RAM Size | 512 x 8 |
| Voltage - Supply (Vcc/Vdd) | 2V ~ 5.5V |
| Data Converters | A/D 10x10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 28-SOIC (0.295", 7.50mm Width) |
| Supplier Device Package | 28-SOIC |
| Purchase URL | https://www.e-xfl.com/product-detail/microchip-technology/pic18lf2321t-i-so |

### 3.6.4 PLL IN INTOSC MODES

The 4x Phase Locked Loop (PLL) can be used with the internal oscillator block to produce faster device clock speeds than are normally possible with the internal oscillator sources. When enabled, the PLL produces a clock speed of 16 MHz or 32 MHz.

Unlike HSPLL mode, the PLL is controlled through software. The control bit, PLLEN (OSCTUNE<6>), is used to enable or disable its operation. If PLL is enabled and a Two-Speed Start-up from wake is performed, execution is delayed until the PLL starts.

The PLL is available when the device is configured to use the internal oscillator block as its primary clock source (FOSC<3:0> = 1001 or 1000). Additionally, the PLL will only function when the selected output frequency is either 4 MHz or 8 MHz (OSCCON<6:4> = 111 or 110). If both of these conditions are not met, the PLL is disabled and the PLLEN bit remains clear (writes are ignored).

### 3.6.5 INTOSC FREQUENCY DRIFT

The factory calibrates the internal oscillator block output (INTOSC) for 8 MHz. However, this frequency may drift as VDD or temperature changes and can affect the controller operation in a variety of ways. It is possible to adjust the INTOSC frequency by modifying the value in the OSCTUNE register. This has no effect on the INTRC clock source frequency.

Tuning the INTOSC source requires knowing when to make the adjustment, in which direction it should be made and in some cases, how large a change is needed. Three compensation techniques are discussed in **Section 3.6.5.1 "Compensating with the EUSART"**, **Section 3.6.5.2 "Compensating with the Timers"** and **Section 3.6.5.3 "Compensating with the CCP Module in Capture Mode"** but other techniques may be used.

**REGISTER 3-1: OSCTUNE: OSCILLATOR TUNING REGISTER**

| R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| INTSRC | PLLEN(1) | — | TUN4 | TUN3 | TUN2 | TUN1 | TUN0 |
| bit 7 | | | | | | | bit 0 |

bit 7 **INTSRC:** Internal Oscillator Low-Frequency Source Select bit
1 = 31.25 kHz device clock derived from 8 MHz INTOSC source (divide-by-256 enabled)
0 = 31 kHz device clock derived directly from INTRC internal oscillator

bit 6 **PLLEN:** Frequency Multiplier PLL for INTOSC Enable bit(1)
1 = PLL enabled for INTOSC (4 MHz and 8 MHz only)
0 = PLL disabled

**Note 1:** Available only in certain oscillator configurations; otherwise, this bit is unavailable and reads as '0'. See **Section 3.6.4 "PLL in INTOSC Modes"** for details.

bit 5 **Unimplemented:** Read as '0'

bit 4-0 **TUN<4:0>:** Frequency Tuning bits
01111 = Maximum frequency
• •
• •
00001
00000 = Center frequency. Oscillator module is running at the calibrated frequency.
11111
• •
• •
10000 = Minimum frequency

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

## 5.4 Brown-out Reset (BOR)

PIC18F2221/2321/4221/4321 family devices implement a BOR circuit that provides the user with a number of configuration and power-saving options. The BOR is controlled by the BORV<1:0> and BOREN<1:0> Configuration bits. There are a total of four BOR configurations which are summarized in Table 5-1.

The BOR threshold is set by the BORV<1:0> bits. If BOR is enabled (any values of BOREN<1:0>, except '00'), any drop of VDD below VBOR (parameter D005) for greater than TBOR (parameter 35) will reset the device. A Reset may or may not occur if VDD falls below VBOR for less than TBOR. The chip will remain in Brown-out Reset until VDD rises above VBOR.

If the Power-up Timer is enabled, it will be invoked after VDD rises above VBOR; it then will keep the chip in Reset for an additional time delay, TPWRT (parameter 33). If VDD drops below VBOR while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be initialized. Once VDD rises above VBOR, the Power-up Timer will execute the additional time delay.

BOR and the Power-on Timer (PWRT) are independently configured. Enabling BOR Reset does not automatically enable the PWRT.

### 5.4.1 SOFTWARE ENABLED BOR

When BOREN<1:0> = 01, the BOR can be enabled or disabled by the user in software. This is done with the control bit, SBOREN (RCON<6>). Setting SBOREN enables the BOR to function as previously described. Clearing SBOREN disables the BOR entirely. The SBOREN bit operates only in this mode; otherwise it is read as '0'.

Placing the BOR under software control gives the user the additional flexibility of tailoring the application to its environment without having to reprogram the device to change BOR configuration. It also allows the user to tailor device power consumption in software by eliminating the incremental current that the BOR consumes. While the BOR current is typically very small, it may have some impact in low-power applications.

| **Note:** | Even when BOR is under software control, the Brown-out Reset voltage level is still set by the BORV<1:0> Configuration bits. It cannot be changed in software. |
|---|---|

### 5.4.2 DETECTING BOR

When Brown-out Reset is enabled, the $\overline{BOR}$ bit always resets to '0' on any Brown-out Reset or Power-on Reset event. This makes it difficult to determine if a Brown-out Reset event has occurred just by reading the state of $\overline{BOR}$ alone. A more reliable method is to simultaneously check the state of both $\overline{POR}$ and $\overline{BOR}$. This assumes that the $\overline{POR}$ bit is reset to '1' in software immediately after any Power-on Reset event. If $\overline{BOR}$ is '0' while $\overline{POR}$ is '1', it can be reliably assumed that a Brown-out Reset event has occurred.

### 5.4.3 DISABLING BOR IN SLEEP MODE

When BOREN<1:0> = 10, the BOR remains under hardware control and operates as previously described. Whenever the device enters Sleep mode, however, the BOR is automatically disabled. When the device returns to any other operating mode, BOR is automatically re-enabled.

This mode allows for applications to recover from brown-out situations, while actively executing code, when the device requires BOR protection the most. At the same time, it saves additional power in Sleep mode by eliminating the small incremental BOR current.

**TABLE 5-1: BOR CONFIGURATIONS**

| BOR Configuration | | Status of SBOREN (RCON<6>) | BOR Operation |
|---|---|---|---|
| BOREN1 | BOREN0 | | |
| 0 | 0 | Unavailable | BOR disabled; must be enabled by reprogramming the Configuration bits. |
| 0 | 1 | Available | BOR enabled in software; operation controlled by SBOREN. |
| 1 | 0 | Unavailable | BOR enabled in hardware in Run and Idle modes, disabled during Sleep mode. |
| 1 | 1 | Unavailable | BOR enabled in hardware; must be disabled by reprogramming the Configuration bits. |

**TABLE 5-4: INITIALIZATION CONDITIONS FOR ALL REGISTERS**

| Register | Applicable Devices | | | | Power-on Reset, Brown-out Reset | MCLR Resets, WDT Reset, RESET Instruction, Stack Resets | Wake-up via WDT or Interrupt |
|---|---|---|---|---|---|---|---|
| TOSU | 2221 | 2321 | 4221 | 4321 | ---0 0000 | ---0 0000 | ---0 uuuu(3) |
| TOSH | 2221 | 2321 | 4221 | 4321 | 0000 0000 | 0000 0000 | uuuu uuuu(3) |
| TOSL | 2221 | 2321 | 4221 | 4321 | 0000 0000 | 0000 0000 | uuuu uuuu(3) |
| STKPTR | 2221 | 2321 | 4221 | 4321 | 00-0 0000 | uu-0 0000 | uu-u uuuu(3) |
| PCLATU | 2221 | 2321 | 4221 | 4321 | --00 0000 | --00 0000 | --uu uuuu |
| PCLATH | 2221 | 2321 | 4221 | 4321 | 0000 0000 | 0000 0000 | uuuu uuuu |
| PCL | 2221 | 2321 | 4221 | 4321 | 0000 0000 | 0000 0000 | PC + 2(2) |
| TBLPTRU | 2221 | 2321 | 4221 | 4321 | --00 0000 | --00 0000 | --uu uuuu |
| TBLPTRH | 2221 | 2321 | 4221 | 4321 | 0000 0000 | 0000 0000 | uuuu uuuu |
| TBLPTRL | 2221 | 2321 | 4221 | 4321 | 0000 0000 | 0000 0000 | uuuu uuuu |
| TABLAT | 2221 | 2321 | 4221 | 4321 | 0000 0000 | 0000 0000 | uuuu uuuu |
| PRODH | 2221 | 2321 | 4221 | 4321 | xxxx xxxx | uuuu uuuu | uuuu uuuu |
| PRODL | 2221 | 2321 | 4221 | 4321 | xxxx xxxx | uuuu uuuu | uuuu uuuu |
| INTCON | 2221 | 2321 | 4221 | 4321 | 0000 000x | 0000 000u | uuuu uuuu(1) |
| INTCON2 | 2221 | 2321 | 4221 | 4321 | 1111 -1-1 | 1111 -1-1 | uuuu -u-u(1) |
| INTCON3 | 2221 | 2321 | 4221 | 4321 | 11-0 0-00 | 11-0 0-00 | uu-u u-uu(1) |
| INDF0 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |
| POSTINC0 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |
| POSTDEC0 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |
| PREINC0 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |
| PLUSW0 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |
| FSR0H | 2221 | 2321 | 4221 | 4321 | ---- 0000 | ---- 0000 | ---- uuuu |
| FSR0L | 2221 | 2321 | 4221 | 4321 | xxxx xxxx | uuuu uuuu | uuuu uuuu |
| WREG | 2221 | 2321 | 4221 | 4321 | xxxx xxxx | uuuu uuuu | uuuu uuuu |
| INDF1 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |
| POSTINC1 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |
| POSTDEC1 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |
| PREINC1 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |
| PLUSW1 | 2221 | 2321 | 4221 | 4321 | N/A | N/A | N/A |

**Legend:** u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

**Note 1:** One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

**2:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

**3:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

**4:** See Table 5-3 for Reset value for specific condition.

**5:** Bits 6 and 7 of PORTA, LATA and TRISA are enabled, depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read '0'.

#### 6.1.2.4 Stack Full and Underflow Resets

Device Resets on stack overflow and stack underflow conditions are enabled by setting the STVREN bit in Configuration Register 4L. When STVREN is set, a full or underflow will set the appropriate STKFUL or STKUNF bit and then cause a device Reset. When STVREN is cleared, a full or underflow condition will set the appropriate STKFUL or STKUNF bit but not cause a device Reset. The STKFUL or STKUNF bits are cleared by the user software or a Power-on Reset.

### 6.1.3 FAST REGISTER STACK

A Fast Register Stack is provided for the STATUS, WREG and BSR registers, to provide a “fast return” option for interrupts. The stack for each register is only one level deep and is neither readable nor writable. It is loaded with the current value of the corresponding register when the processor vectors for an interrupt. All interrupt sources will push values into the stack registers. The values in the registers are then loaded back into their associated registers if the `RETFIE, FAST` instruction is used to return from the interrupt.

If both low and high-priority interrupts are enabled, the stack registers cannot be used reliably to return from low-priority interrupts. If a high-priority interrupt occurs while servicing a low-priority interrupt, the Stack register values stored by the low-priority interrupt will be overwritten. In these cases, users must save the key registers in software during a low-priority interrupt.

If interrupt priority is not used, all interrupts may use the Fast Register Stack for returns from interrupt. If no interrupts are used, the Fast Register Stack can be used to restore the STATUS, WREG and BSR registers at the end of a subroutine call. To use the Fast Register Stack for a subroutine call, a `CALL label, FAST` instruction must be executed to save the STATUS, WREG and BSR registers to the Fast Register Stack. A `RETURN, FAST` instruction is then executed to restore these registers from the Fast Register Stack.

Example 6-1 shows a source code example that uses the Fast Register Stack during a subroutine call and return.

**EXAMPLE 6-1: FAST REGISTER STACK CODE EXAMPLE**

```
CALL  SUB1, FAST    ;STATUS, WREG, BSR
                    ;SAVED IN FAST REGISTER
                    ;STACK
        •
        •

SUB1    •
        •
      RETURN, FAST  ;RESTORE VALUES SAVED
                    ;IN FAST REGISTER STACK
```

### 6.1.4 LOOK-UP TABLES IN PROGRAM MEMORY

There may be programming situations that require the creation of data structures, or look-up tables, in program memory. For PIC18 devices, look-up tables can be implemented in two ways:

- Computed `GOTO`
- Table Reads

#### 6.1.4.1 Computed `GOTO`

A computed `GOTO` is accomplished by adding an offset to the program counter. An example is shown in Example 6-2.

A look-up table can be formed with an `ADDWF PCL` instruction and a group of `RETLW nn` instructions. The W register is loaded with an offset into the table before executing a call to that table. The first instruction of the called routine is the `ADDWF PCL` instruction. The next instruction executed will be one of the `RETLW nn` instructions that returns the value ‘`nn`’ to the calling function.

The offset value (in WREG) specifies the number of bytes that the program counter should advance and should be multiples of 2 (LSb = `0`).

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

**EXAMPLE 6-2: COMPUTED `GOTO` USING AN OFFSET VALUE**

```
        MOVF    OFFSET, W
        CALL    TABLE
ORG     nn00h
TABLE   ADDWF   PCL
        RETLW   nnh
        RETLW   nnh
        RETLW   nnh
        .
        .
        .
```

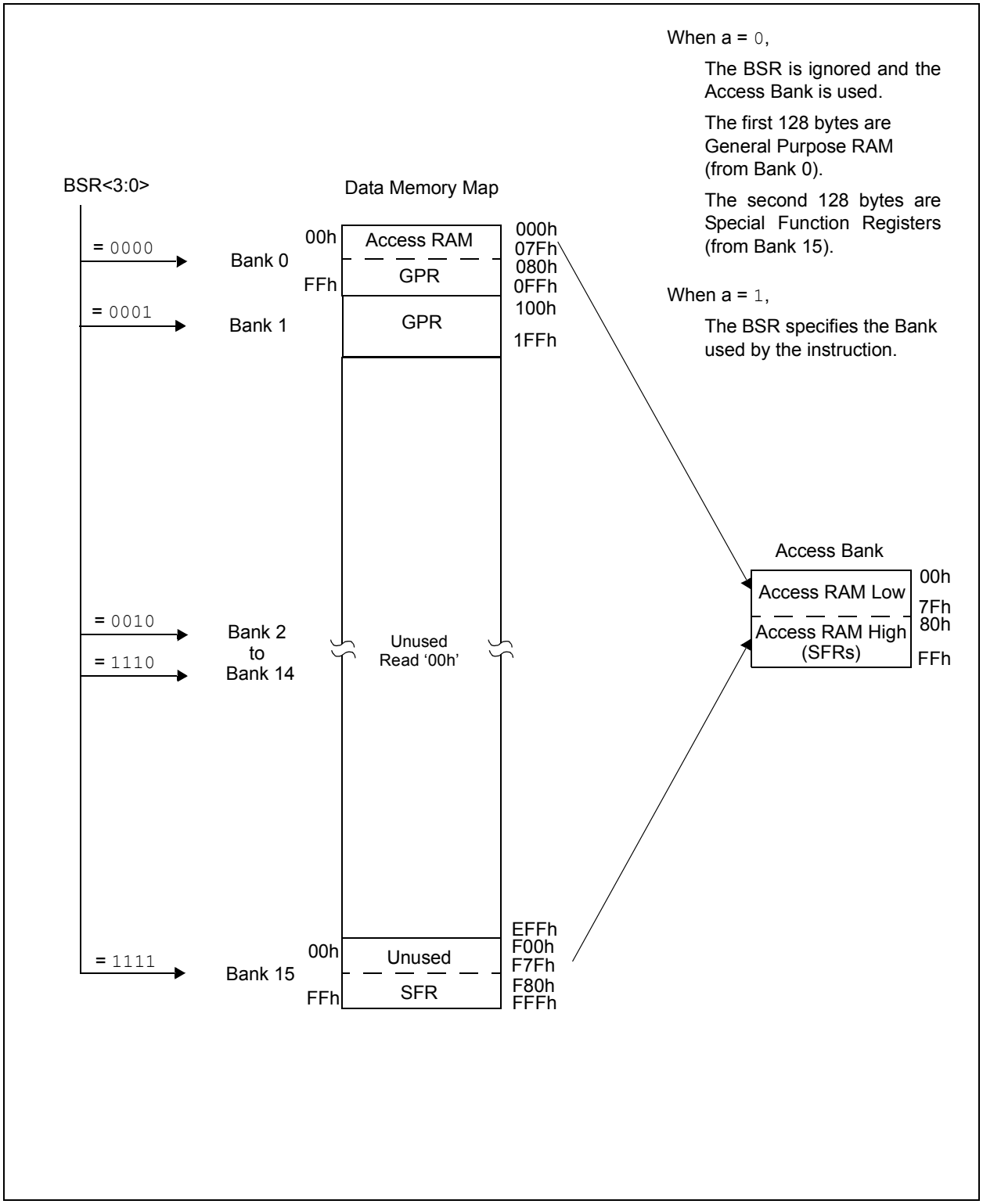
#### 6.1.4.2 Table Reads and Table Writes

A better method of storing data in program memory allows two bytes of data to be stored in each instruction location.

Look-up table data may be stored two bytes per program word by using table reads and writes. The Table Pointer (TBLPTR) register specifies the byte address and the Table Latch (TABLAT) register contains the data that is read from or written to program memory. Data is transferred to or from program memory one byte at a time.

Table read and table write operations are discussed further in **Section 7.1 “Table Reads and Table Writes”**.

**FIGURE 6-5: DATA MEMORY MAP FOR PIC18F2221/2321/4221/4321 FAMILY DEVICES**



**REGISTER 11-1: TRISE REGISTER (40/44-PIN DEVICES ONLY)**

| R-0 | R-0 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| IBF | OBF | IBOV | PSPMODE | — | TRISE2 | TRISE1 | TRISE0 |
| bit 7 | | | | | | | bit 0 |

bit 7 **IBF:** Input Buffer Full Status bit
1 = A word has been received and waiting to be read by the CPU
0 = No word has been received

bit 6 **OBF:** Output Buffer Full Status bit
1 = The output buffer still holds a previously written word
0 = The output buffer has been read

bit 5 **IBOV:** Input Buffer Overflow Detect bit (in Microprocessor mode)
1 = A write occurred when a previously input word has not been read (must be cleared in software)
0 = No overflow occurred

bit 4 **PSPMODE:** Parallel Slave Port Mode Select bit
1 = Parallel Slave Port mode
0 = General Purpose I/O mode

bit 3 **Unimplemented:** Read as '0'

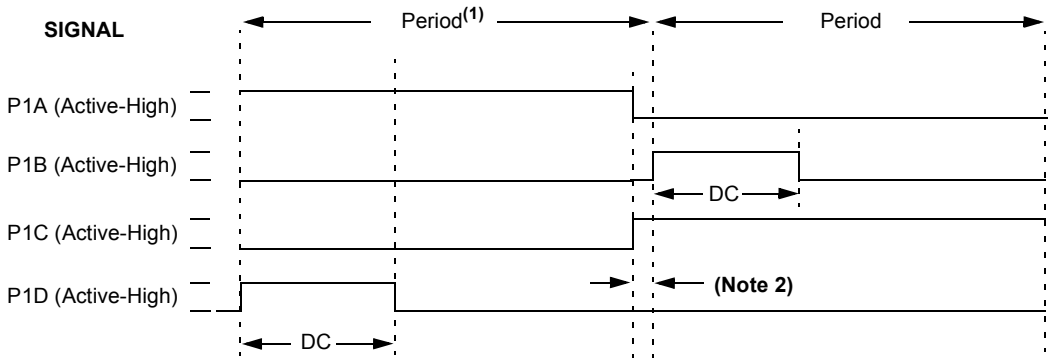
bit 2 **TRISE2:** RE2 Direction Control bit
1 = Input
0 = Output

bit 1 **TRISE1:** RE1 Direction Control bit
1 = Input
0 = Output

bit 0 **TRISE0:** RE0 Direction Control bit
1 = Input
0 = Output

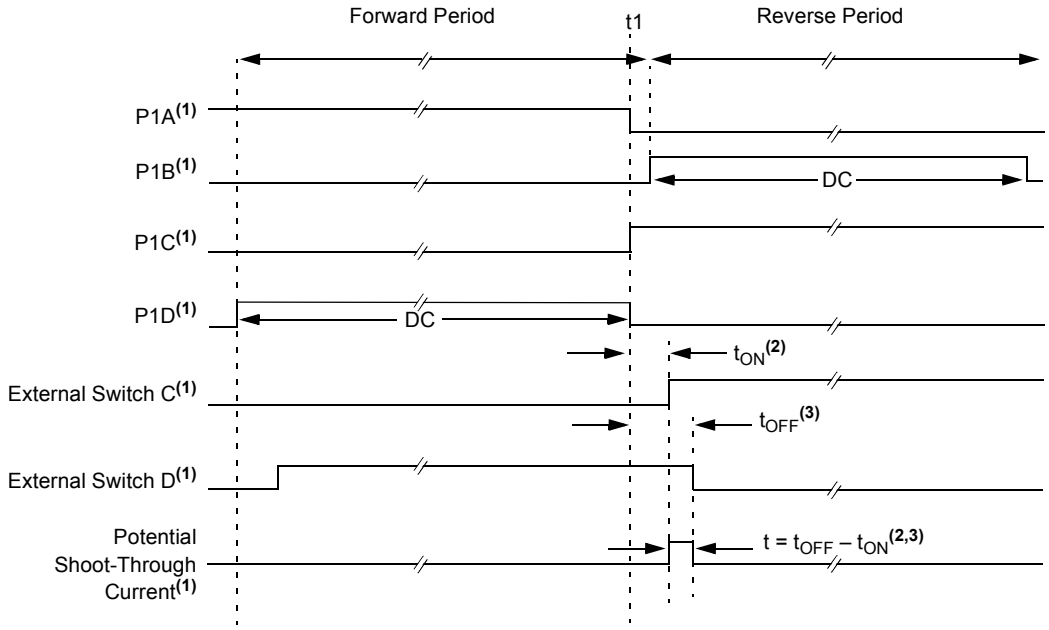
| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

**FIGURE 17-8: PWM DIRECTION CHANGE**




**Note 1:** The direction bit in the CCP1 Control register (CCP1CON<7>) is written any time during the PWM cycle.
**2:** When changing directions, the P1A and P1C signals switch before the end of the current PWM cycle at intervals of 4 TOSC, 16 TOSC or 64 TOSC, depending on the Timer2 prescaler value. The modulated P1B and P1D signals are inactive at this time.

**FIGURE 17-9: PWM DIRECTION CHANGE AT NEAR 100% DUTY CYCLE**




**Note 1:** All signals are shown as active-high.
**2:** $t_{ON}$ is the turn-on delay of power switch QC and its driver.
**3:** $t_{OFF}$ is the turn-off delay of power switch QD and its driver.

**REGISTER 19-1: TXSTA: TRANSMIT STATUS AND CONTROL REGISTER**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R-1 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CSRC | TX9 | TXEN | SYNC | SENDB | BRGH | TRMT | TX9D |
| bit 7 | | | | | | | bit 0 |

bit 7 **CSRC:** Clock Source Select bit

Asynchronous mode:
Don't care.

Synchronous mode:
1 = Master mode (clock generated internally from BRG)
0 = Slave mode (clock from external source)

bit 6 **TX9:** 9-bit Transmit Enable bit

1 = Selects 9-bit transmission
0 = Selects 8-bit transmission

bit 5 **TXEN:** Transmit Enable bit

1 = Transmit enabled
0 = Transmit disabled

**Note:** SREN/CREN overrides TXEN in Sync mode.

bit 4 **SYNC:** EUSART Mode Select bit

1 = Synchronous mode
0 = Asynchronous mode

bit 3 **SENDB:** Send Break Character bit

Asynchronous mode:
1 = Send Sync Break on next transmission (cleared by hardware upon completion)
0 = Sync Break transmission completed

Synchronous mode:
Don't care.

bit 2 **BRGH:** High Baud Rate Select bit

Asynchronous mode:
1 = High speed
0 = Low speed

Synchronous mode:
Unused in this mode.

bit 1 **TRMT:** Transmit Shift Register Status bit

1 = TSR empty
0 = TSR full

bit 0 **TX9D:** 9th bit of Transmit Data

Can be address/data bit or a parity bit.

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

**TABLE 19-3: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)**

| BAUD RATE (K) | SYNC = 0, BRGH = 0, BRG16 = 1 | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | FOSC = 40.000 MHz | | | FOSC = 20.000 MHz | | | FOSC = 10.000 MHz | | | FOSC = 8.000 MHz | | |
| | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) |
| 0.3 | 0.300 | 0.00 | 8332 | 0.300 | 0.02 | 4165 | 0.300 | 0.02 | 2082 | 0.300 | -0.04 | 1665 |
| 1.2 | 1.200 | 0.02 | 2082 | 1.200 | -0.03 | 1041 | 1.200 | -0.03 | 520 | 1.201 | -0.16 | 415 |
| 2.4 | 2.402 | 0.06 | 1040 | 2.399 | -0.03 | 520 | 2.404 | 0.16 | 259 | 2.403 | -0.16 | 207 |
| 9.6 | 9.615 | 0.16 | 259 | 9.615 | 0.16 | 129 | 9.615 | 0.16 | 64 | 9.615 | -0.16 | 51 |
| 19.2 | 19.231 | 0.16 | 129 | 19.231 | 0.16 | 64 | 19.531 | 1.73 | 31 | 19.230 | -0.16 | 25 |
| 57.6 | 58.140 | 0.94 | 42 | 56.818 | -1.36 | 21 | 56.818 | -1.36 | 10 | 55.555 | 3.55 | 8 |
| 115.2 | 113.636 | -1.36 | 21 | 113.636 | -1.36 | 10 | 125.000 | 8.51 | 4 | — | — | — |

| BAUD RATE (K) | SYNC = 0, BRGH = 0, BRG16 = 1 | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|
| | FOSC = 4.000 MHz | | | FOSC = 2.000 MHz | | | FOSC = 1.000 MHz | | |
| | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) |
| 0.3 | 0.300 | 0.04 | 832 | 0.300 | -0.16 | 415 | 0.300 | -0.16 | 207 |
| 1.2 | 1.202 | 0.16 | 207 | 1.201 | -0.16 | 103 | 1.201 | -0.16 | 51 |
| 2.4 | 2.404 | 0.16 | 103 | 2.403 | -0.16 | 51 | 2.403 | -0.16 | 25 |
| 9.6 | 9.615 | 0.16 | 25 | 9.615 | -0.16 | 12 | — | — | — |
| 19.2 | 19.231 | 0.16 | 12 | — | — | — | — | — | — |
| 57.6 | 62.500 | 8.51 | 3 | — | — | — | — | — | — |
| 115.2 | 125.000 | 8.51 | 1 | — | — | — | — | — | — |

| BAUD RATE (K) | SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1 | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | FOSC = 40.000 MHz | | | FOSC = 20.000 MHz | | | FOSC = 10.000 MHz | | | FOSC = 8.000 MHz | | |
| | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) |
| 0.3 | 0.300 | 0.00 | 33332 | 0.300 | 0.00 | 16665 | 0.300 | 0.00 | 8332 | 0.300 | -0.01 | 6665 |
| 1.2 | 1.200 | 0.00 | 8332 | 1.200 | 0.02 | 4165 | 1.200 | 0.02 | 2082 | 1.200 | -0.04 | 1665 |
| 2.4 | 2.400 | 0.02 | 4165 | 2.400 | 0.02 | 2082 | 2.402 | 0.06 | 1040 | 2.400 | -0.04 | 832 |
| 9.6 | 9.606 | 0.06 | 1040 | 9.596 | -0.03 | 520 | 9.615 | 0.16 | 259 | 9.615 | -0.16 | 207 |
| 19.2 | 19.193 | -0.03 | 520 | 19.231 | 0.16 | 259 | 19.231 | 0.16 | 129 | 19.230 | -0.16 | 103 |
| 57.6 | 57.803 | 0.35 | 172 | 57.471 | -0.22 | 86 | 58.140 | 0.94 | 42 | 57.142 | 0.79 | 34 |
| 115.2 | 114.943 | -0.22 | 86 | 116.279 | 0.94 | 42 | 113.636 | -1.36 | 21 | 117.647 | -2.12 | 16 |

| BAUD RATE (K) | SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1 | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|
| | FOSC = 4.000 MHz | | | FOSC = 2.000 MHz | | | FOSC = 1.000 MHz | | |
| | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) | Actual Rate (K) | % Error | SPBRG value (decimal) |
| 0.3 | 0.300 | 0.01 | 3332 | 0.300 | -0.04 | 1665 | 0.300 | -0.04 | 832 |
| 1.2 | 1.200 | 0.04 | 832 | 1.201 | -0.16 | 415 | 1.201 | -0.16 | 207 |
| 2.4 | 2.404 | 0.16 | 415 | 2.403 | -0.16 | 207 | 2.403 | -0.16 | 103 |
| 9.6 | 9.615 | 0.16 | 103 | 9.615 | -0.16 | 51 | 9.615 | -0.16 | 25 |
| 19.2 | 19.231 | 0.16 | 51 | 19.230 | -0.16 | 25 | 19.230 | -0.16 | 12 |
| 57.6 | 58.824 | 2.12 | 16 | 55.555 | 3.55 | 8 | — | — | — |
| 115.2 | 111.111 | -3.55 | 8 | — | — | — | — | — | — |

**FIGURE 19-12: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)**

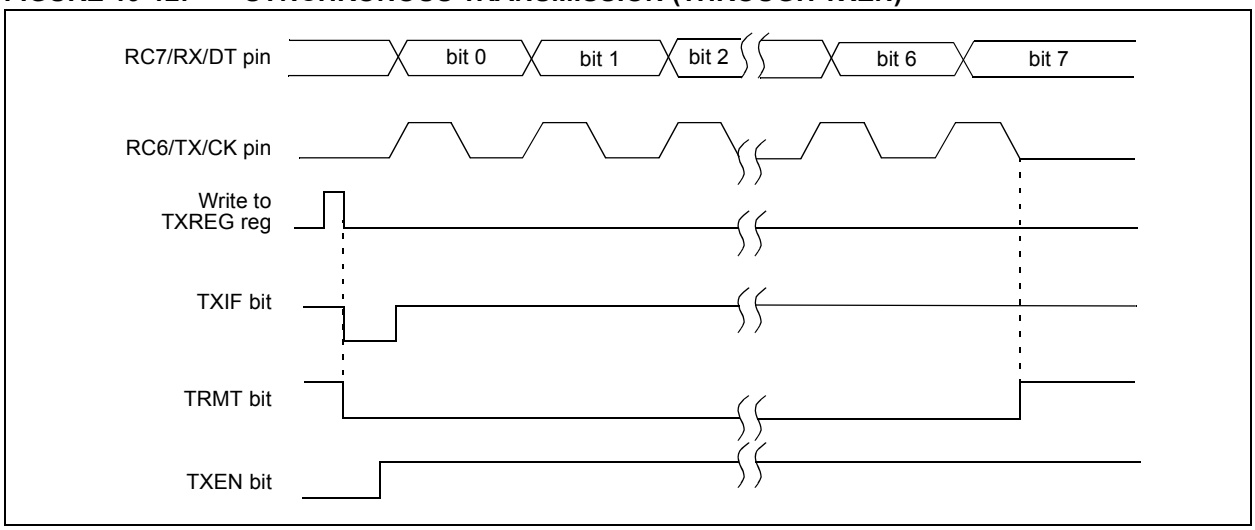



**TABLE 19-7: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION**

| Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset Values on page |
|---|---|---|---|---|---|---|---|---|---|
| INTCON | GIE/GIEH | PEIE/GIEL | TMR0IE | INT0IE | RBIE | TMR0IF | INT0IF | RBIF | 55 |
| PIR1 | PSPIF(1) | ADIF | RCIF | TXIF | SSPIF | CCP1IF | TMR2IF | TMR1IF | 58 |
| PIE1 | PSPIE(1) | ADIE | RCIE | TXIE | SSPIE | CCP1IE | TMR2IE | TMR1IE | 58 |
| IPR1 | PSPIP(1) | ADIP | RCIP | TXIP | SSPIP | CCP1IP | TMR2IP | TMR1IP | 58 |
| RCSTA | SPEN | RX9 | SREN | CREN | ADDEN | FERR | OERR | RX9D | 57 |
| TXREG | EUSART Transmit Register | | | | | | | | 57 |
| TXSTA | CSRC | TX9 | TXEN | SYNC | SENDB | BRGH | TRMT | TX9D | 57 |
| BAUDCON | ABDOVF | RCIDL | RXDTP | TXCKP | BRG16 | — | WUE | ABDEN | 57 |
| SPBRGH | EUSART Baud Rate Generator Register High Byte | | | | | | | | 57 |
| SPBRG | EUSART Baud Rate Generator Register Low Byte | | | | | | | | 57 |

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used for synchronous master transmission.

**Note 1:** These bits are unimplemented on 28-pin devices and read as '0'.

The analog reference voltage is software selectable to either the device's positive and negative supply voltage ($V_{DD}$ and $V_{SS}$), or the voltage level on the RA3/AN3/$V_{REF+}$ and RA2/AN2/$V_{REF-}$/C$V_{REF}$ pins.

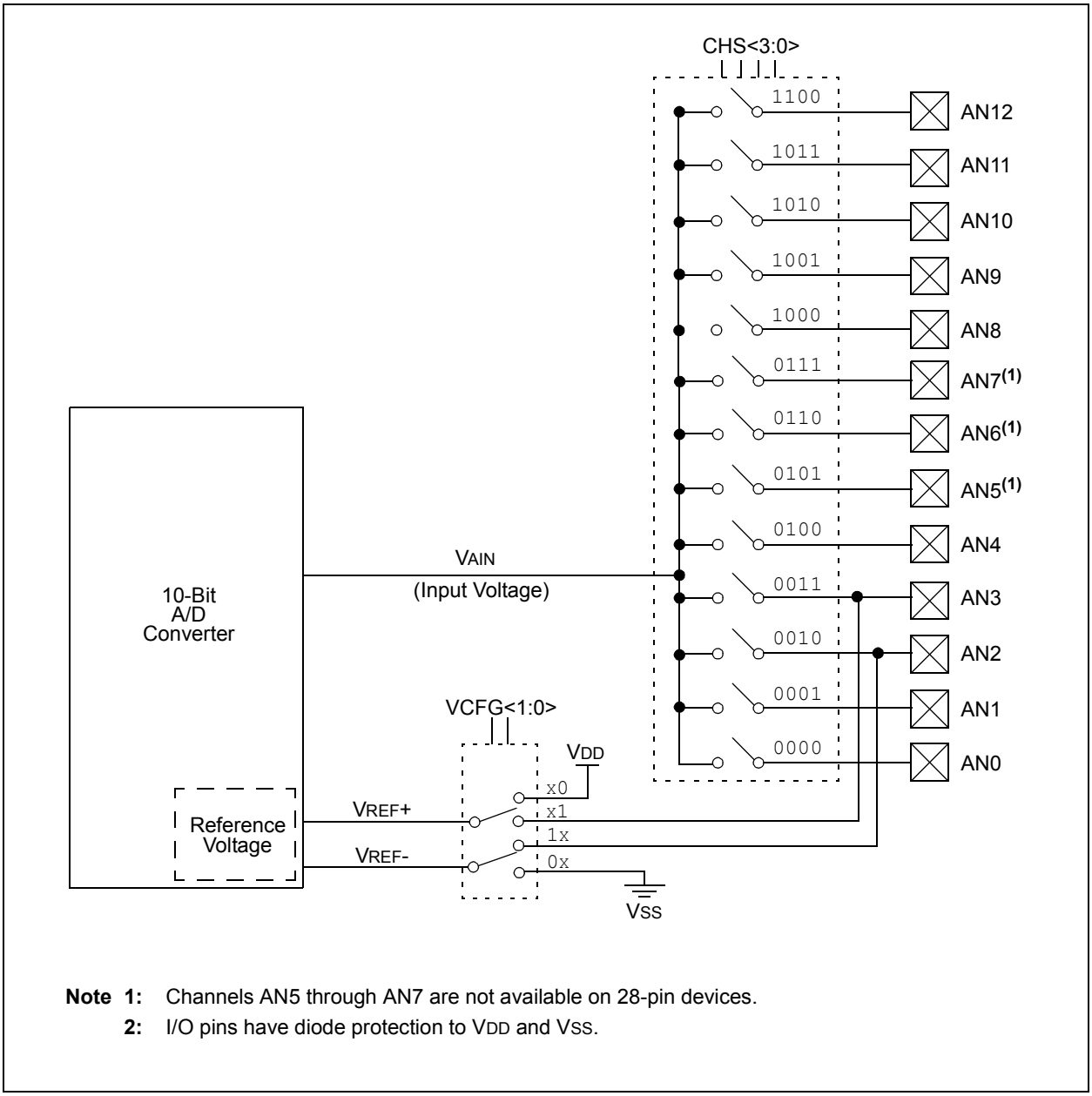
The A/D converter has a unique feature of being able to operate while the device is in Sleep mode. To operate in Sleep, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

The output of the sample and hold is the input into the converter, which generates the result via successive approximation.

A device Reset forces all registers to their Reset state. This forces the A/D module to be turned off and any conversion in progress is aborted.

Each port pin associated with the A/D converter can be configured as an analog input, or as a digital I/O. The ADRESH and ADRESL registers contain the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRESH:ADRESL register pair, the GO/DONE bit (ADCON0 register) is cleared and A/D Interrupt Flag bit, ADIF, is set. The block diagram of the A/D module is shown in Figure 20-1.

**FIGURE 20-1: A/D BLOCK DIAGRAM**




**Note 1:** Channels AN5 through AN7 are not available on 28-pin devices.

**2:** I/O pins have diode protection to $V_{DD}$ and $V_{SS}$.

## 21.0 COMPARATOR MODULE

The analog comparator module contains two comparators that can be configured in a variety of ways. The inputs can be selected from the analog inputs multiplexed with pins RA0 through RA5, as well as the on-chip voltage reference (see **Section 22.0 "Comparator Voltage Reference Module"**). The digital outputs (normal or inverted) are available at the pin level and can also be read through the control register.

The CMCON register (Register 21-1) selects the comparator input and output configuration. Block diagrams of the various comparator configurations are shown in Figure 21-1.

**REGISTER 21-1: CMCON: COMPARATOR CONTROL REGISTER**

| R-0 | R-0 | R/W-0 | R/W-0 | R/W-0 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| C2OUT | C1OUT | C2INV | C1INV | CIS | CM2 | CM1 | CM0 |
| bit 7 | | | | | | | bit 0 |

bit 7 **C2OUT**: Comparator 2 Output bit
When C2INV = 0:
1 = C2 VIN+ > C2 VIN-
0 = C2 VIN+ < C2 VIN-
When C2INV = 1:
1 = C2 VIN+ < C2 VIN-
0 = C2 VIN+ > C2 VIN-

bit 6 **C1OUT**: Comparator 1 Output bit
When C1INV = 0:
1 = C1 VIN+ > C1 VIN-
0 = C1 VIN+ < C1 VIN-
When C1INV = 1:
1 = C1 VIN+ < C1 VIN-
0 = C1 VIN+ > C1 VIN-

bit 5 **C2INV**: Comparator 2 Output Inversion bit
1 = C2 output inverted
0 = C2 output not inverted

bit 4 **C1INV**: Comparator 1 Output Inversion bit
1 = C1 output inverted
0 = C1 output not inverted

bit 3 **CIS**: Comparator Input Switch bit
When CM<2:0> = 110:
1 = C1 VIN- connects to RA3/AN3/VREF+
C2 VIN- connects to RA2/AN2/VREF-/CVREF
0 = C1 VIN- connects to RA0/AN0
C2 VIN- connects to RA1/AN1

bit 2-0 **CM<2:0>**: Comparator Mode bits
Figure 21-1 shows the Comparator modes and the CM<2:0> bit settings.

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

**NOTES:**

## 22.0 COMPARATOR VOLTAGE REFERENCE MODULE

The comparator voltage reference is a 16-tap resistor ladder network that provides a selectable reference voltage. Although its primary purpose is to provide a reference for the analog comparators, it may also be used independently of them.

A block diagram of the module is shown in Figure 22-1. The resistor ladder is segmented to provide two ranges of CVREF values and has a power-down function to conserve power when the reference is not being used. The module's supply reference can be provided from either device VDD/VSS or an external voltage reference.

### 22.1 Configuring the Comparator Voltage Reference

The voltage reference module is controlled through the CVRCON register (Register 22-1). The comparator voltage reference provides two ranges of output voltage, each with 16 distinct levels. The range to be used is selected by the CVRR bit (CVRCON<5>). The primary difference between the ranges is the size of the steps selected by the CVREF selection bits (CVR<3:0>), with one range offering finer resolution. The equations used to calculate the output of the comparator voltage reference are as follows:

If CVRR = 1:
CVREF = ((CVR<3:0>)/24) x CVRSRC

If CVRR = 0:
CVREF = (CVRSRC x 1/4) + (((CVR<3:0>)/32) x CVRSRC)

The comparator reference supply voltage can come from either VDD and VSS, or the external VREF+ and VREF- that are multiplexed with RA2 and RA3. The voltage source is selected by the CVRSS bit (CVRCON<4>).

The settling time of the comparator voltage reference must be considered when changing the CVREF output (see Table 27-3 in **Section 27.0 "Electrical Characteristics"**).

**REGISTER 22-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CVREN | CVROE(1) | CVRR | CVRSS | CVR3 | CVR2 | CVR1 | CVR0 |
| bit 7 | | | | | | | bit 0 |

bit 7 **CVREN**: Comparator Voltage Reference Enable bit
1 = CVREF circuit powered on
0 = CVREF circuit powered down

bit 6 **CVROE**: Comparator VREF Output Enable bit(1)
1 = CVREF voltage level is also output on the RA2/AN2/VREF-/CVREF pin
0 = CVREF voltage is disconnected from the RA2/AN2/VREF-/CVREF pin

**Note 1:** CVROE overrides the TRISA<2> bit setting.

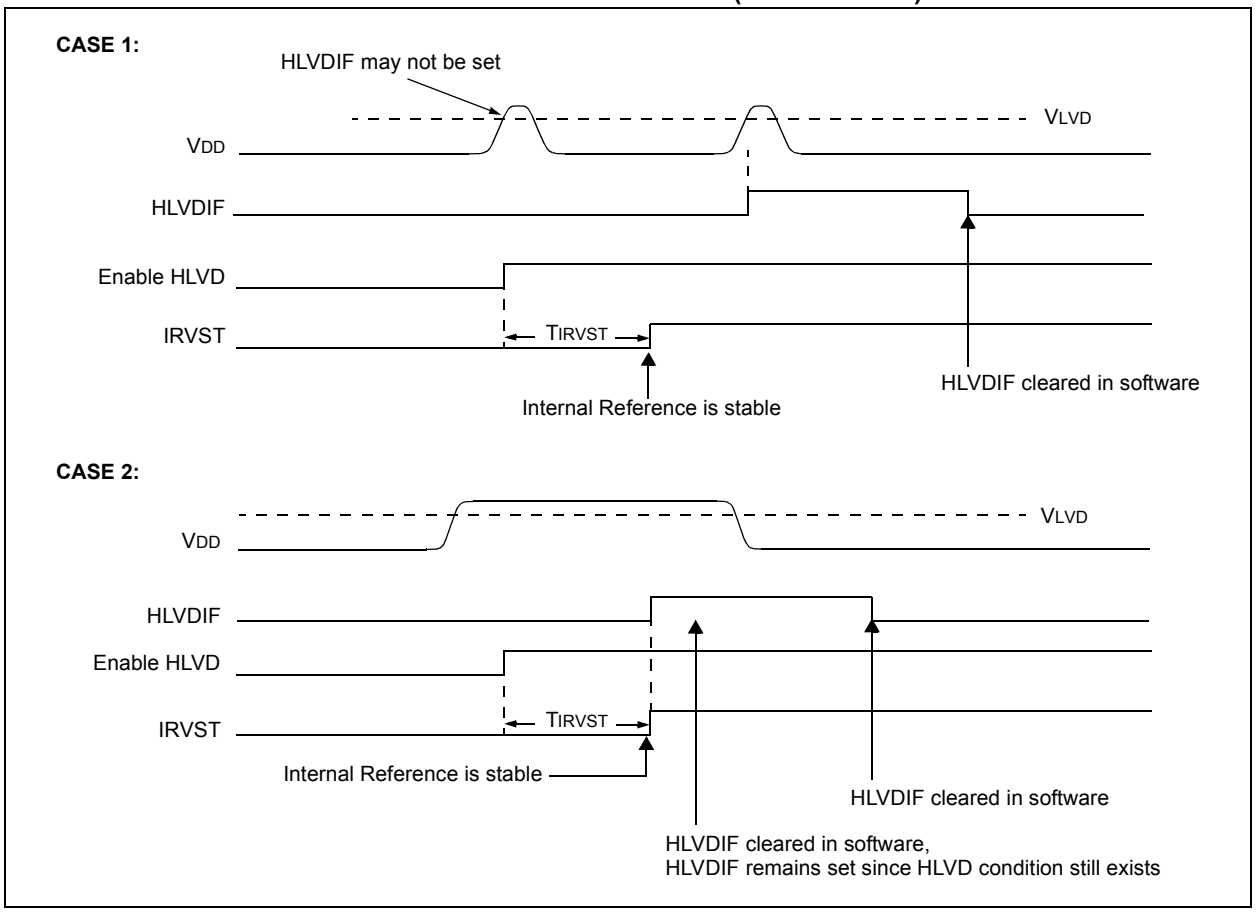
bit 5 **CVRR**: Comparator VREF Range Selection bit
1 = 0.00 CVRSRC to 0.667 CVRSRC, with CVRSRC/24 step size (low range)
0 = 0.25 CVRSRC to 0.75 CVRSRC, with CVRSRC/32 step size (high range)

bit 4 **CVRSS**: Comparator VREF Source Selection bit
1 = Comparator reference source, CVRSRC = (VREF+) – (VREF-)
0 = Comparator reference source, CVRSRC = VDD – VSS

bit 3-0 **CVR<3:0>:** Comparator VREF Value Selection bits (0 ≤ (CVR<3:0>) ≤ 15)
When CVRR = 1:
CVREF = ((CVR<3:0>)/24) • (CVRSRC)
When CVRR = 0:
CVREF = (CVRSRC/4) + ((CVR<3:0>)/32) • (CVRSRC)

| Legend: | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

**FIGURE 23-3: HIGH-VOLTAGE DETECT OPERATION (VDIRMAG = 1)**

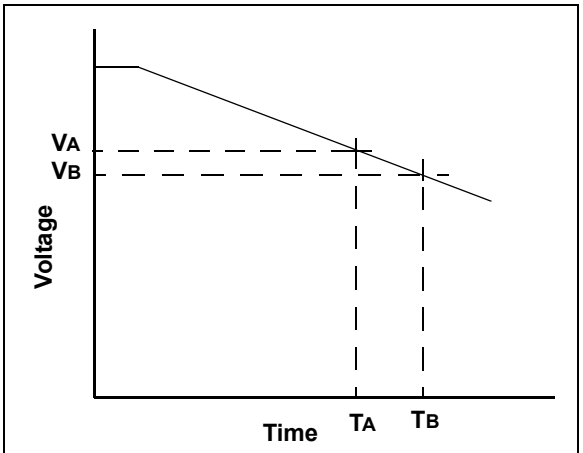



## 23.5 Applications

In many applications, the ability to detect a drop below or rise above a particular threshold is desirable. For example, the HLVD module could be periodically enabled to detect a Universal Serial Bus (USB) attach or detach. This assumes the device is powered by a lower voltage source than the USB when detached. An attach would indicate a high-voltage detect from, for example, 3.3V to 5V (the voltage on USB) and vice versa for a detach. This feature could save a design a few extra components and an attach signal (input pin).

For general battery applications, Figure 23-4 shows a possible voltage curve. Over time, the device voltage decreases. When the device voltage reaches voltage VA, the HLVD logic generates an interrupt at time TA. The interrupt could cause the execution of an ISR, which would allow the application to perform "housekeeping tasks" and perform a controlled shutdown before the device voltage exits the valid operating range at TB. The HLVD, thus, would give the application a time window, represented by the difference between TA and TB, to safely exit.

**FIGURE 23-4: TYPICAL LOW-VOLTAGE DETECT APPLICATION**




**Legend:** VA = HLVD trip point
VB = Minimum valid device operating voltage

## 24.0 SPECIAL FEATURES OF THE CPU

PIC18F2221/2321/4221/4321 family devices include several features intended to maximize reliability and minimize cost through elimination of external components. These are:

- Oscillator Selection
- Resets:
  - Power-on Reset (POR)
  - Power-up Timer (PWRT)
  - Oscillator Start-up Timer (OST)
  - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- Fail-Safe Clock Monitor
- Two-Speed Start-up
- Code Protection
- ID Locations
- In-Circuit Serial Programming

The oscillator can be configured for the application depending on frequency, power, accuracy and cost. All of the options are discussed in detail in **Section 3.0 "Oscillator Configurations"**.

A complete discussion of device Resets and interrupts is available in previous sections of this data sheet.

In addition to their Power-up and Oscillator Start-up Timers provided for Resets, PIC18F2221/2321/4221/4321 family devices have a Watchdog Timer, which is either permanently enabled via the Configuration bits or software controlled (if configured as disabled).

The inclusion of an internal RC oscillator also provides the additional benefits of a Fail-Safe Clock Monitor (FSCM) and Two-Speed Start-up. FSCM provides for background monitoring of the peripheral clock and automatic switchover in the event of its failure. Two-Speed Start-up enables code to be executed almost immediately on start-up, while the primary clock source completes its start-up delays.

All of these features are enabled and configured by setting the appropriate Configuration register bits.

### 24.1 Configuration Bits

The Configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped starting at program memory location 300000h.

The user will note that address 300000h is beyond the user program memory space. In fact, it belongs to the configuration memory space (300000h-3FFFFFh), which can only be accessed using table reads and table writes.

Programming the Configuration registers is done in a manner similar to programming the Flash memory. The WR bit in the EECON1 register starts a self-timed write to the Configuration register. In normal operation mode, a TBLWT instruction with the TBLPTR pointing to the Configuration register sets up the address and the data for the Configuration register write. Setting the WR bit starts a long write to the Configuration register. The Configuration registers are written a byte at a time. To write or erase a configuration cell, a TBLWT instruction can write a '1' or a '0' into the cell. For additional details on Flash programming, refer to **Section 7.5 "Writing to Flash Program Memory"**.

**TABLE 24-1: CONFIGURATION BITS AND DEVICE IDs**

| File Name | | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Default/ Unprogrammed Value |
|---|---|---|---|---|---|---|---|---|---|---|
| 300001h | CONFIG1H | IESO | FCMEN | — | — | FOSC3 | FOSC2 | FOSC1 | FOSC0 | 00-- 0111 |
| 300002h | CONFIG2L | — | — | — | BORV1 | BORV0 | BOREN1 | BOREN0 | $\overline{\text{PWRTEN}}$ | ---1 1111 |
| 300003h | CONFIG2H | — | — | — | WDTPS3 | WDTPS2 | WDTPS1 | WDTPS0 | WDTEN | ---1 1111 |
| 300005h | CONFIG3H | MCLRE | — | — | — | — | LPT1OSC | PBADEN | CCP2MX | 1--- -011 |
| 300006h | CONFIG4L | $\overline{\text{DEBUG}}$ | XINST | BBSIZ1 | BBSIZ0 | r | LVP | — | STVREN | 1000 01-1 |
| 300008h | CONFIG5L | — | — | — | — | — | — | CP1 | CP0 | ---- --11 |
| 300009h | CONFIG5H | CPD | CPB | — | — | — | — | — | — | 11-- ---- |
| 30000Ah | CONFIG6L | — | — | — | — | — | — | WRT1 | WRT0 | ---- --11 |
| 30000Bh | CONFIG6H | WRTD | WRTB | WRTC | — | — | — | — | — | 111- ---- |
| 30000Ch | CONFIG7L | — | — | — | — | — | — | EBTR1 | EBTR0 | ---- --11 |
| 30000Dh | CONFIG7H | — | EBTRB | — | — | — | — | — | — | -1-- ---- |
| 3FFFFEh | DEVID1(1) | DEV2 | DEV1 | DEV0 | REV4 | REV3 | REV2 | REV1 | REV0 | xxxx xxxx(2) |
| 3FFFFFh | DEVID2(1) | DEV10 | DEV9 | DEV8 | DEV7 | DEV6 | DEV5 | DEV4 | DEV3 | 0000 1100 |

**Legend:** x = unknown, u = unchanged, - = unimplemented, q = value depends on condition, r = reserved, maintain as '0'. Shaded cells are unimplemented, read as '0'.

**Note 1:** Unimplemented in PIC18F2221/4221 devices; maintain these bits set.

**2:** See Register 24-14 for DEVID1 values. DEVID registers are read-only and cannot be programmed by the user.

**REGISTER 24-4: CONFIG3H: CONFIGURATION REGISTER 3 HIGH (BYTE ADDRESS 300005h)**

| R/P-1 | U-0 | U-0 | U-0 | U-0 | R/P-0 | R/P-1 | R/P-1 |
|---|---|---|---|---|---|---|---|
| MCLRE | — | — | — | — | LPT1OSC | PBADEN | CCP2MX |
| bit 7 | | | | | | | bit 0 |

bit 7 **MCLRE:** $\overline{\text{MCLR}}$ Pin Enable bit
1 = $\overline{\text{MCLR}}$ pin enabled; RE3 input pin disabled
0 = RE3 input pin enabled; $\overline{\text{MCLR}}$ disabled

bit 6-3 **Unimplemented:** Read as '0'

bit 2 **LPT1OSC:** Low-Power Timer1 Oscillator Enable bit
1 = Timer1 configured for low-power operation
0 = Timer1 configured for higher power operation

bit 1 **PBADEN:** PORTB A/D Enable bit
(Affects ADCON1 Reset state. ADCON1 controls PORTB<4:0> pin configuration.)
1 = PORTB<4:0> pins are configured as analog input channels on Reset
0 = PORTB<4:0> pins are configured as digital I/O on Reset

bit 0 **CCP2MX:** CCP2 MUX bit
1 = CCP2 input/output is multiplexed with RC1
0 = CCP2 input/output is multiplexed with RB3

| **Legend:** | | |
|---|---|---|
| R = Readable bit | P = Programmable bit | U = Unimplemented bit, read as '0' |
| -n = Value when device is unprogrammed | | u = Unchanged from programmed state |

**COMF** **Complement f**

Syntax: COMF f {,d {,a}}

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: $(\bar{f}) \rightarrow$ dest

Status Affected: N, Z

Encoding:

| | | | |
|---|---|---|---|
| 0001 | 11da | ffff | ffff |

Description: The contents of register 'f' are complemented. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).
If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

| Q1 | Q2 | Q3 | Q4 |
|---|---|---|---|
| Decode | Read register 'f' | Process Data | Write to destination |

Example: `COMF REG, 0, 0`

Before Instruction
REG = 13h
After Instruction
REG = 13h
W = ECh

**CPFSEQ** **Compare f with W, Skip if f = W**

Syntax: CPFSEQ f {,a}

Operands: $0 \le f \le 255$
$a \in [0,1]$

Operation: (f) – (W),
skip if (f) = (W)
(unsigned comparison)

Status Affected: None

Encoding:

| | | | |
|---|---|---|---|
| 0110 | 001a | ffff | ffff |

Description: Compares the contents of data memory location 'f' to the contents of W by performing an unsigned subtraction.
If 'f' = W, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction.
If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1(2)
**Note:** 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

| Q1 | Q2 | Q3 | Q4 |
|---|---|---|---|
| Decode | Read register 'f' | Process Data | No operation |

If skip:

| Q1 | Q2 | Q3 | Q4 |
|---|---|---|---|
| No operation | No operation | No operation | No operation |

If skip and followed by 2-word instruction:

| Q1 | Q2 | Q3 | Q4 |
|---|---|---|---|
| No operation | No operation | No operation | No operation |
| No operation | No operation | No operation | No operation |

Example:
```
HERE    CPFSEQ REG, 0
NEQUAL  :
EQUAL   :
```

Before Instruction
PC Address = HERE
W = ?
REG = ?
After Instruction
If REG = W;
PC = Address (EQUAL)
If REG ≠ W;
PC = Address (NEQUAL)

**TABLE 27-21: MASTER SSP I²C™ BUS DATA REQUIREMENTS**

| Param. No. | Symbol | Characteristic | | Min | Max | Units | Conditions |
|---|---|---|---|---|---|---|---|
| 100 | THIGH | Clock High Time | 100 kHz mode | 2(TOSC)(BRG + 1) | — | ms | |
| | | | 400 kHz mode | 2(TOSC)(BRG + 1) | — | ms | |
| | | | 1 MHz mode(1) | 2(TOSC)(BRG + 1) | — | ms | |
| 101 | TLOW | Clock Low Time | 100 kHz mode | 2(TOSC)(BRG + 1) | — | ms | |
| | | | 400 kHz mode | 2(TOSC)(BRG + 1) | — | ms | |
| | | | 1 MHz mode(1) | 2(TOSC)(BRG + 1) | — | ms | |
| 102 | TR | SDA and SCL Rise Time | 100 kHz mode | — | 1000 | ns | CB is specified to be from 10 to 400 pF |
| | | | 400 kHz mode | 20 + 0.1 CB | 300 | ns | |
| | | | 1 MHz mode(1) | — | 300 | ns | |
| 103 | TF | SDA and SCL Fall Time | 100 kHz mode | — | 300 | ns | CB is specified to be from 10 to 400 pF |
| | | | 400 kHz mode | 20 + 0.1 CB | 300 | ns | |
| | | | 1 MHz mode(1) | — | 100 | ns | |
| 90 | TSU:STA | Start Condition Setup Time | 100 kHz mode | 2(TOSC)(BRG + 1) | — | ms | Only relevant for Repeated Start condition |
| | | | 400 kHz mode | 2(TOSC)(BRG + 1) | — | ms | |
| | | | 1 MHz mode(1) | 2(TOSC)(BRG + 1) | — | ms | |
| 91 | THD:STA | Start Condition Hold Time | 100 kHz mode | 2(TOSC)(BRG + 1) | — | ms | After this period, the first clock pulse is generated |
| | | | 400 kHz mode | 2(TOSC)(BRG + 1) | — | ms | |
| | | | 1 MHz mode(1) | 2(TOSC)(BRG + 1) | — | ms | |
| 106 | THD:DAT | Data Input Hold Time | 100 kHz mode | 0 | — | ns | |
| | | | 400 kHz mode | 0 | 0.9 | ms | |
| 107 | TSU:DAT | Data Input Setup Time | 100 kHz mode | 250 | — | ns | **(Note 2)** |
| | | | 400 kHz mode | 100 | — | ns | |
| 92 | TSU:STO | Stop Condition Setup Time | 100 kHz mode | 2(TOSC)(BRG + 1) | — | ms | |
| | | | 400 kHz mode | 2(TOSC)(BRG + 1) | — | ms | |
| | | | 1 MHz mode(1) | 2(TOSC)(BRG + 1) | — | ms | |
| 109 | TAA | Output Valid from Clock | 100 kHz mode | — | 3500 | ns | |
| | | | 400 kHz mode | — | 1000 | ns | |
| | | | 1 MHz mode(1) | — | — | ns | |
| 110 | TBUF | Bus Free Time | 100 kHz mode | 4.7 | — | ms | Time the bus must be free before a new transmission can start |
| | | | 400 kHz mode | 1.3 | — | ms | |
| D102 | CB | Bus Capacitive Loading | | — | 400 | pF | |

**Note 1:** Maximum pin capacitance = 10 pF for all I²C pins.

**2:** A Fast mode I²C bus device can be used in a Standard mode I²C bus system, but parameter 107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line, parameter 102 + parameter 107 = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCL line is released.